
HAT2077R

Silicon N Channel MOS FET
High Speed Power Switching

HITACHI

ADE-208-1228 (Z)

1st. Edition

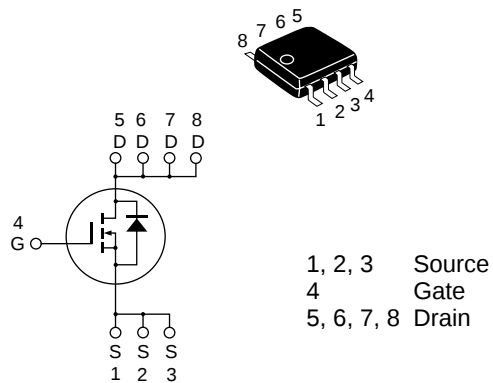
Mar. 2001

Features

- Low on-resistance
- Low drive current
- High density mounting

Outline

SOP-8



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	200	V
Gate to source voltage	V_{GSS}	±30	V
Drain current	I_D	3	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	24	A
Body-drain diode reverse drain current	I_{DR}	3	A
Channel dissipation	P_{ch} ^{Note2}	2.5	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	–55 to +150	°C

Note: 1. $PW \leq 10\mu s$, duty cycle $\leq 1\%$

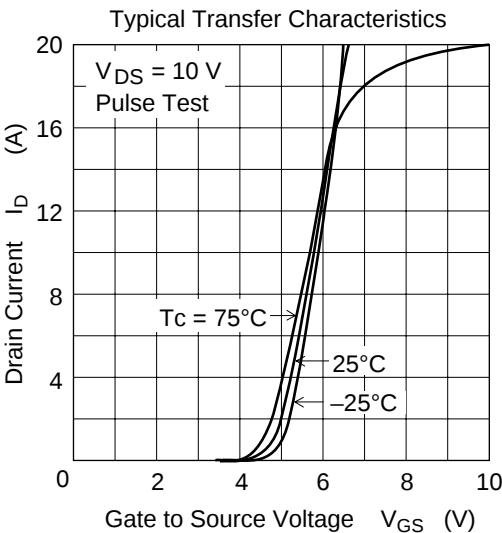
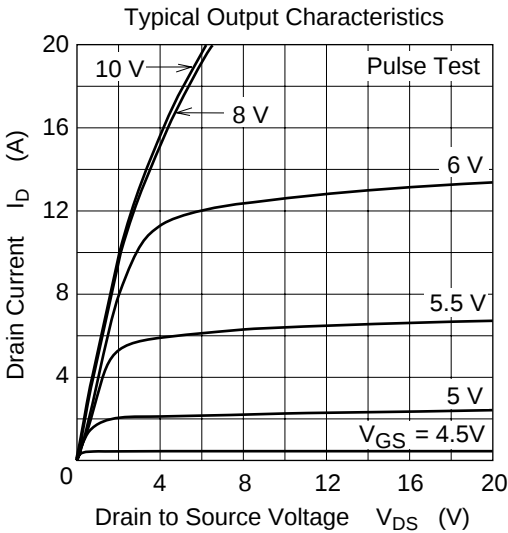
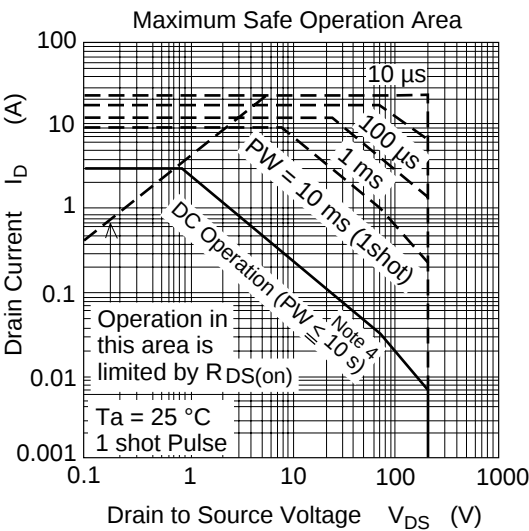
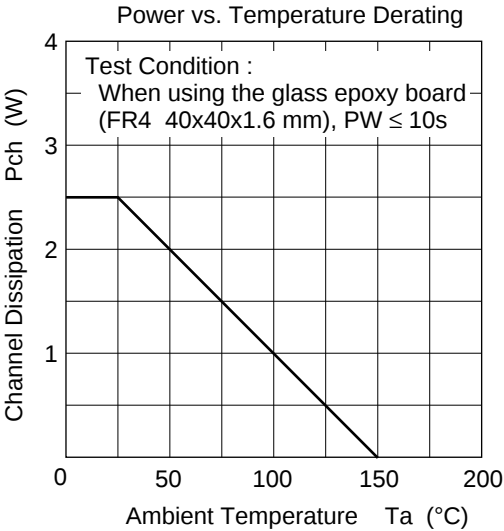
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$

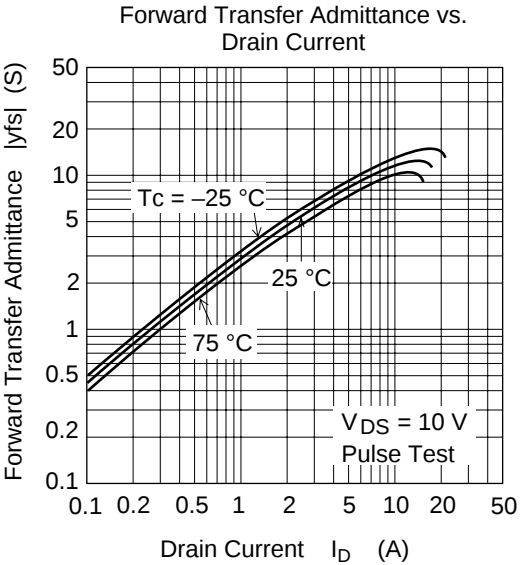
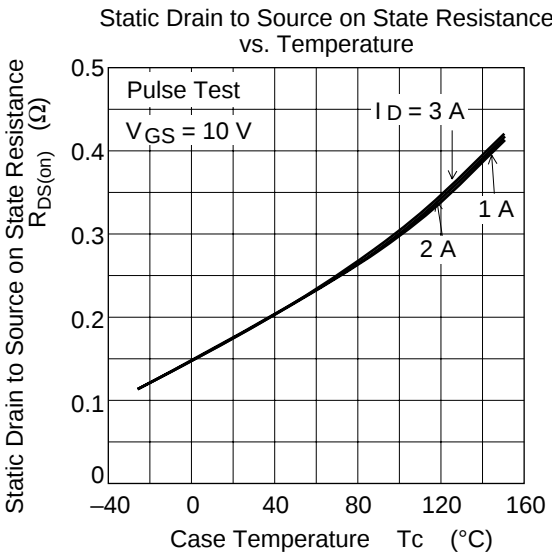
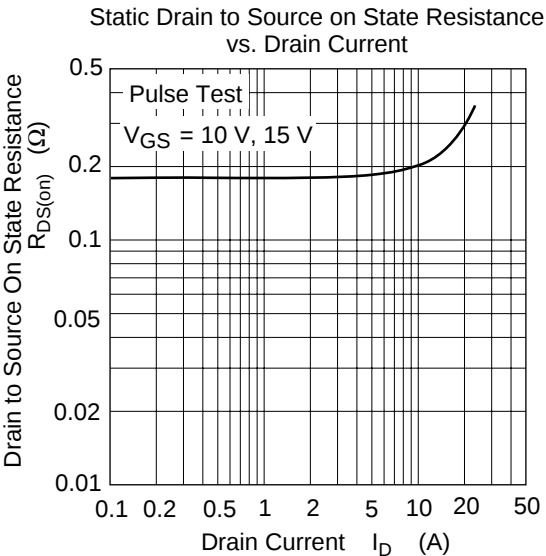
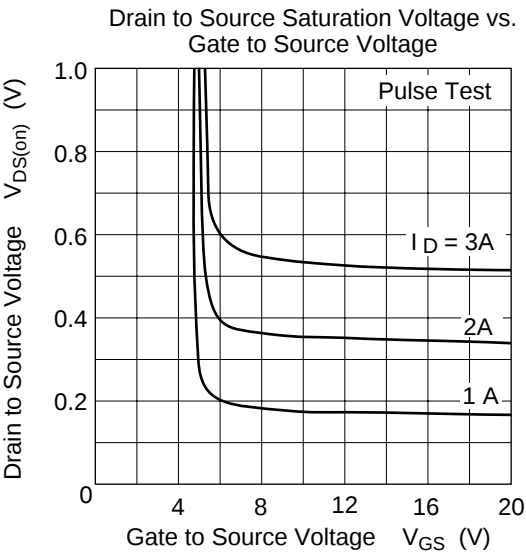
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	200	—	—	V	$I_D = 10mA$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	±0.1	μA	$V_{GS} = \pm 30V$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 200V$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	3.0	—	4.5	V	$I_D = 1mA$, $V_{DS} = 10V$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.18	0.235	Ω	$I_D = 1.5A$, $V_{GS} = 10V$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	2.3	3.8	—	S	$I_D = 1.5A$, $V_{DS} = 10V$ ^{Note3}
Input capacitance	C_{iss}	—	830	—	pF	$V_{DS} = 25V$
Output capacitance	C_{oss}	—	115	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	23	—	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}$	—	23	—	ns	$V_{DD} \cong 100V$, $I_D = 1.5A$
Rise time	t_r	—	10	—	ns	$V_{GS} = 10V$
Turn-off delay time	$t_{d(off)}$	—	70	—	ns	$R_L = 66.7\Omega$
Fall time	t_f	—	10	—	ns	$R_g = 10\Omega$
Total gate charge	Q_g	—	23	—	nC	$V_{DD} = 160V$
Gate to source charge	Q_{gs}	—	3.5	—	nC	$V_{GS} = 10V$
Gate to drain charge	Q_{gd}	—	10	—	nC	$I_D = 3A$
Body-drain diode forward voltage	V_{DF}	—	0.75	1.15	V	$I_F = 3A$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	75	—	ns	$I_F = 3A$, $V_{GS} = 0$ $diF/dt \cong 100A/\mu s$

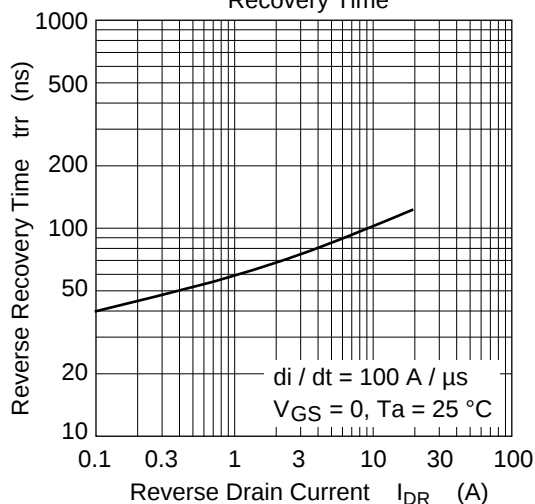
Note: 3. Pulse test

Main Characteristics

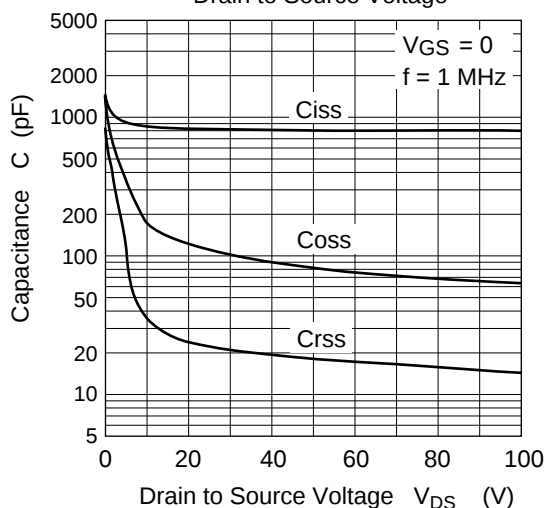




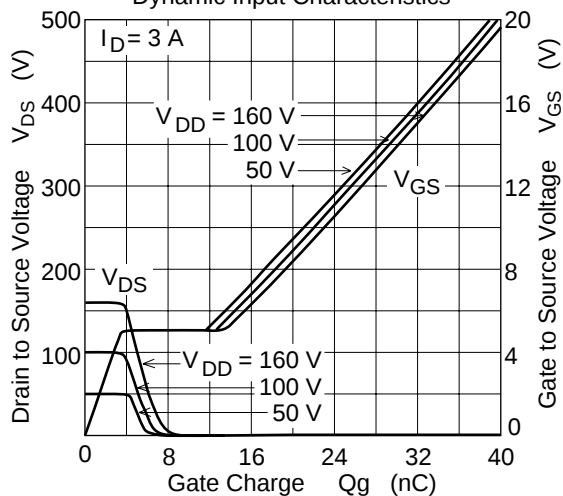
Body-Drain Diode Reverse Recovery Time



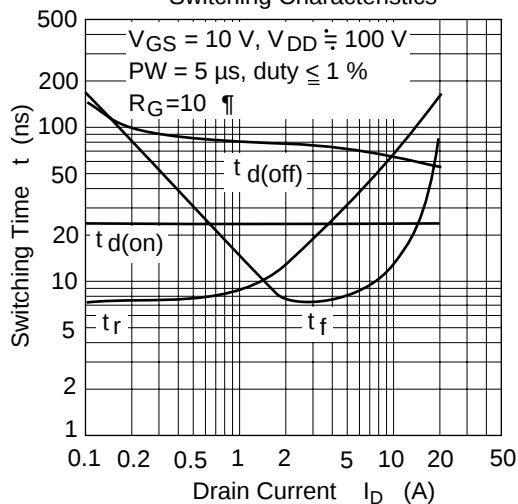
Typical Capacitance vs. Drain to Source Voltage



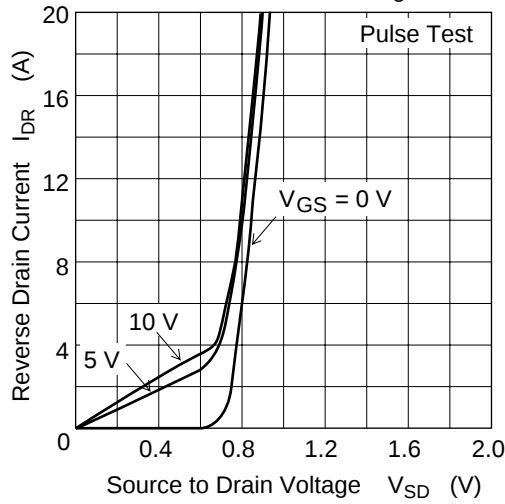
Dynamic Input Characteristics



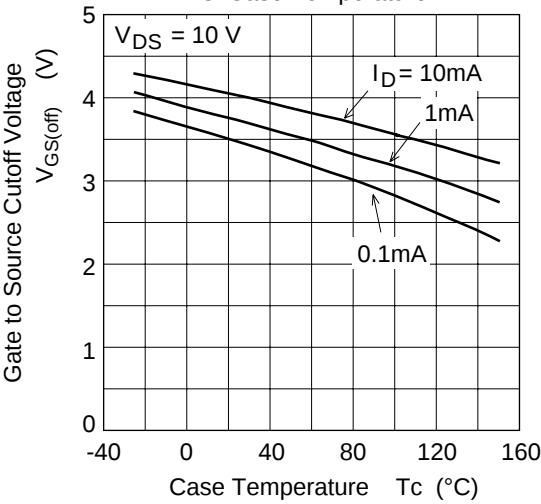
Switching Characteristics



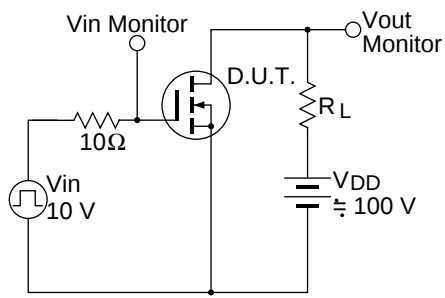
Reverse Drain Current vs.
Source to Drain Voltage



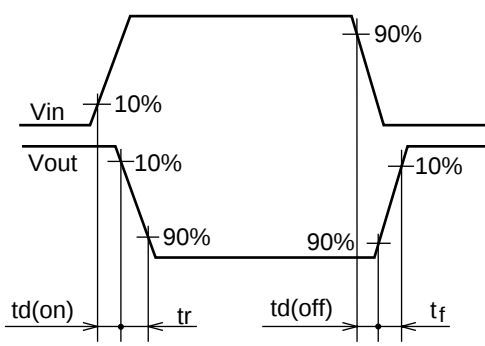
Gate to Source Cutoff Voltage
vs. Case Temperature

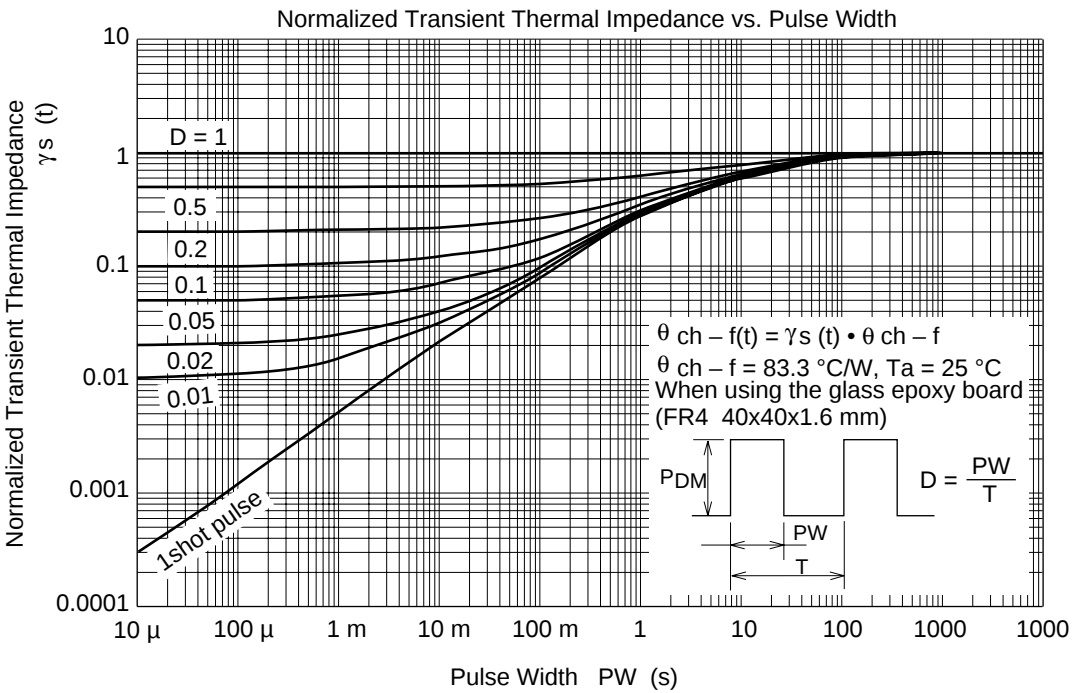


Switching Time Test Circuit



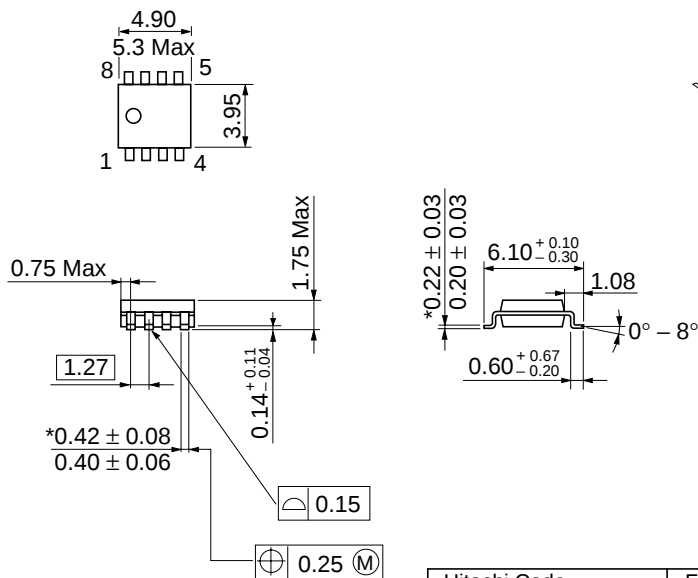
Switching Time Waveform





Package Dimensions

As of January, 2001
Unit: mm



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-8DA
JEDEC	Conforms
EIAJ	—
Mass (reference value)	0.085 g

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